

NPN SILICON GERMANIUM RF TRANSISTOR NESG250134

NPN SIGE RF TRANSISTOR FOR MEDIUM OUTPUT POWER AMPLIFICATION (800 mW) 3-PIN POWER MINIMOLD (34 PACKAGE)

FEATURES

- This product is suitable for medium output power (800 mW) amplification
 - Po = 29 dBm TYP. @ VcE = 3.6 V, Pin = 15 dBm, f = 460 MHz
 - Po = 29 dBm TYP. @ Vce = 3.6 V, Pin = 20 dBm, f = 900 MHz
- MSG (Maximum Stable Gain) = 23 dB TYP., @ Vce = 3.6 V, Ic = 100 mA, f = 460 MHz
- Using UHS2-HV process (SiGe technology), VCBO (ABSOLUTE MAXIMUM RATINGS) = 20 V
- 3-pin power minimold (34 package)

ORDERING INFORMATION

Part Number	Quantity	Supplying Form
NESG250134-A	25 pcs (Non reel)	• 12 mm wide embossed taping
NESG250134-T1-A	1 kpcs/reel	Pin 2 (Emitter) face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office. Unit sample quantity is 25 pcs.

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	20	V
Collector to Emitter Voltage	Vceo	9.2	V
Emitter to Base Voltage	Vebo	2.8	V
Collector Current	lc	500	mA
Total Power Dissipation	Ptot Note	1.5	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-65 to +150	°C

Note Mounted on 34.2 $\text{cm}^2 \times 0.8 \text{ mm}$ (t) glass epoxy PWB

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

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THERMAL RESISTANCE (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Termal Resistance from Junction to Ambient Note	Rth _{j-a}	80	°C/W

Note Mounted on 34.2 $\text{cm}^2 \times 0.8 \text{ mm}$ (t) glass epoxy PWB

RECOMMENDED OPERATING RANGE (TA = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Collector to Emitter Voltage	Vce	_	3.6	4.5	V
Collector Current	lc	-	400	500	mA
Input Power Note	Pin	-	12	17	dBm

Note Input power under conditions of $V_{\text{CE}} \leq 4.5$ V, f = 460 MHz

ELECTRICAL CHARACTERISTICS (T_A = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	Ісво	$V_{CB} = 5 V, I_E = 0 mA$	-	-	1	μA
Emitter Cut-off Current	Іево	V _{EB} = 0.5 V, Ic = 0 mA	-	_	1	μA
DC Current Gain	hfe Note 1	Vce = 3 V, lc = 100 mA	80	120	180	-
RF Characteristics						
Gain Bandwidth Product	f⊤	Vce = 3.6 V, Ic = 100 mA, f = 460 MHz	-	10	-	GHz
Insertion Power Gain	S _{21e} ²	Vce = 3.6 V, Ic = 100 mA, f = 460 MHz	-	19	-	dB
Maximum Satble Gain	MSG Note 2	Vce = 3.6 V, Ic = 100 mA, f = 460 MHz	-	23	-	dB
Linner gain (1)	G∟	Vce = 3.6 V, lc (set) = 30 mA (RF OFF), f = 460 MHz, Pin = 0 dBm	16	19	-	dB
Linner gain (2)	G∟	VcE = 3.6 V, lc (set) = 30 mA (RF OFF), f = 900 MHz, Pin = 0 dBm	-	16	-	dB
Output Power (1)	Po	Vce = 3.6 V, lc (set) = 30 mA (RF OFF), f = 460 MHz, Pin = 15 dBm	27	29	-	dBm
Output Power (2)	Po	Vce = 3.6 V, Ic (set) = 30 mA (RF OFF), f = 900 MHz, Pin = 20 dBm	_	29	_	dBm
Collector Efficiency (1)	ηc	Vce = 3.6 V, Ic (set) = 30 mA (RF OFF), f = 460 MHz, Pin = 15 dBm	_	60	_	%
Collector Efficiency (2)	ηс	Vce = 3.6 V, Ic (set) = 30 mA (RF OFF), f = 900 MHz, Pin = 20 dBm	_	60	_	%

Notes 1. Pulse measurement: PW $\leq 350~\mu\text{s},~\text{Duty}~\text{Cycle} \leq 2\%$

$$\textbf{2. MSG} = \left| \frac{S_{21}}{S_{12}} \right|$$

hfe CLASSIFICATION

Rank	FB
Marking	SN
hfe Value	80 to 180

TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)



Base to Emitter Voltage VBE (V)





Remark The graphs indicate nominal characteristics.







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PA EVALUATION BOARD (f = 460 MHz)



Notes

- 1. 38×90 mm, t = 0.8 mm double sided copper clad glass epoxy PWB.
- 2. Back side: GND pattern
- 3. Solder gold plated on pattern
- 4. ∘ O: Through holes

PA EVALUATION CIRCUIT (f = 460 MHz)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENT LIST

	Value	Maker
C1	30 pF	Murata
C2	6 pF	Murata
C3, C4	7 pF	Murata
C5	3 pF	Murata
C6	0.5 pF	Murata
C7	5 pF	Murata
C8	10 pF	Murata
C9, C10	100 nF	Murata
L1	100 nH	Toko
L2	3 nH	Toko
R1	30 Ω	SSM

PA EVALUATION CIRCUIT TYPICAL CHARACTERISTICS





DISTORTION EVALUATION BOARD (f = 460 MHz)



Notes

- 1. 38×90 mm, t = 0.8 mm, double sided copper clad glass epoxy PWB.
- 2. Back side: GND pattern
- 3. Solder gold plated on pattern
- 4. ∘O: Through holes

■ DISTORTION EVALUATION CIRCUIT (f = 460 MHz)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENT LIST

	Value	Maker
C1	47 pF	Murata
C2	12 pF	Murata
C3, C4	7 pF	Murata
C5	3 pF	Murata
C6	6 pF	Murata
C7	0.5 pF	Murata
C8	5 pF	Murata
C9	51 pF	Murata
C10, C12	100 nF	Murata
C11	1 <i>µ</i> F	Murata
L1	100 nH	Toko
L2	15 nH	Toko
R1	30 Ω	SSM

DISTORTION EVALUATION CIRCUIT TYPICAL CHARACTERISTICS



Remark The graph indicates nominal characteristics.

PACKAGE DIMENSIONS

3-PIN POWER MINIMOLD (34 PACKAGE) (UNIT: mm)



PIN CONNECTIONS

- 1. Collector
- 2. Emitter
- 3. Base

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